P29175.A01

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Isao WASEDA et al.

Group Art Unit: Not Yet Assigned

Appl. No.

: 10/565,298

(U.S. National Stage of PCT/JP2004/010721)

I.A. Filed

: July 28, 2004

Examiner: Not Yet Assigned

For

: HEAT TRANSFER TUBE PANEL MODULE AND METHOD OF

CONSTRUCTING EXHAUST HEAT RECOVERY BOILER USING

THE MODULE

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
U.S. Patent and Trademark Office
Customer Service Window, Mail Stop AMENDMENT
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

In accordance with the duty of disclosure under 37 C.F.R. § 1.56 and §§1.97-1.98, Applicants hereby bring the following information to the attention of the Examiner in charge of the above-identified application, which includes information cited and discussed in the specification, the International Search Report, and the International Preliminary Examination Report issued in connection with International Patent Application No. PCT/JP2004/010721, of which the present application is the U.S. National Stage Application. A copy of the International Search Report was enclosed with the papers when entering the U.S. National Stage on January 20, 2006, and a copy of the International Preliminary Examination Report is enclosed herewith. The Examiner is invited to

review these materials to inspect the relevance indicated during international examination with respect to the documents cited therein. The following is a list of the documents cited in the above-noted documents:

U.S. Patent No. 4,685,426 (U.S. Patent Application No. 859,550), together with patent family member Japanese Laid-open Patent Publication No. SHO 62-266301. Applicants note that both of these documents are cited on page 5 of the specification of the present application;

U.S. Patent No. 5,339,891;

Japanese Laid-open Patent Publication No. 2001-41409, together with an English language abstract of the same; and

Japanese Laid-open Patent Publication No. 2002-168403, together with an English language abstract of the same.

Further, Applicants call to the Examiner's attention the following document:

U.S. Patent Application No. 10/563,282 to WASEDA et al., which was filed on January 4, 2006.

Further to 37 C.F.R. §1.98 (a)(2)(ii), copies of the U.S. patent are not enclosed herewith. However, if copies are needed, the Examiner is respectfully requested to contact the undersigned.

Further to the U.S. Patent and Trademark Office's decision to waive the requirement under 37 C.F.R. §1.98 (a)(2)(iii) if the U.S. patent application was filed after June 30, 2003, a copy of the U.S. patent application is not enclosed

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herewith. However, if a copy is needed, the Examiner is respectfully requested

to contact the undersigned.

Applicants respectfully request that the Examiner consider the above

material and cite the same. Copies of the above-noted foreign documents are

attached hereto and all of the above-noted documents are listed on the attached

PTO-1449 Form. The Examiner is requested to initial the appropriate spaces on

the attached Form and to return a copy of the completed Form to Applicants with

the next official communication in the present application.

Applicants note that an Office Action on the merits has not issued in the

present application, and thus no fee is believed necessary to ensure

consideration of the submitted material.

Should the Examiner have any questions, the Examiner is invited to

contact the undersigned at the below-listed telephone number.

Respectfully Submitted,

Isao WASEDA et al.

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	1	U.S. Patent Application No. 10/563,282 to WASEDA et al., which was filed on January 4, 2006.) <u>.</u>
	2 English Language Abstract of JP 2001-041409. 3 English Language Abstract of JP 2002-266301.															
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